

Model RFP-100200N4Z50-2

RF Power

Aluminum Nitride Terminations 10 Watts, 50 Ω



Features

- DC 2.0 GHz
- 10 Watts
- Aluminum Nitride (AIN) Ceramic
- Surface Mountable
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

General Specifications

Resistive Element: Thick film

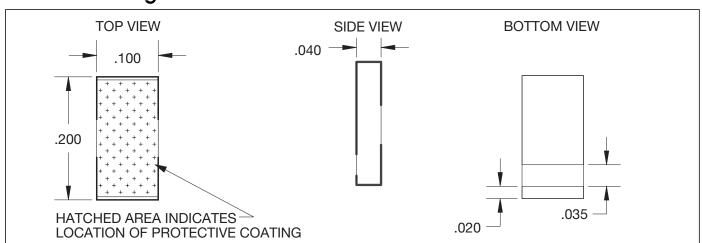
Substrate: Aluminum nitride ceramic
Terminals: Tin/Lead, 90/10 over nickel

Electrical Specifications

Resistance Value: 50 ohms, ±2% Frequency Range: DC - 2.0 GHz Power: 10 Watts V.S.W.R.: 1.25:1

Notes: Tolerance is $\pm .010$, unless otherwise specified. Operating temperature is -55°C to +125°C (see chart). Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions are in inches. **Specifications subject to change without notice.**

Outline Drawing



VER. 12/5/01

Available on Tape and Reel for Pick and Place Manufacturing.

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121

Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

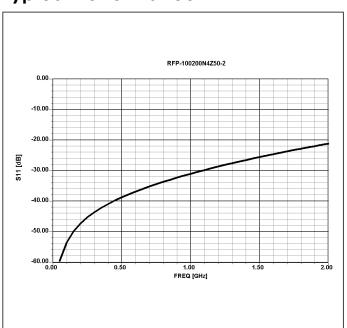


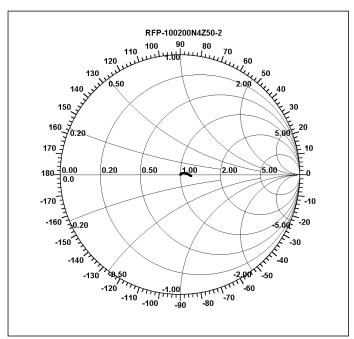
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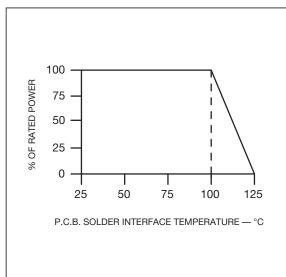


Typical Performance

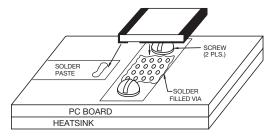




Power Derating



Suggested Mounting Procedures



- 1. Solder part in place using 60/40 type solder with controlled temperature iron (700°F).
- 2. Drill thermal vias through PCB and fill with solder, such as 60/40 type.
- To ensure good thermal connectivity to heat sink, drill and tap heatsink and mount PCB board to heat sink using screws.







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